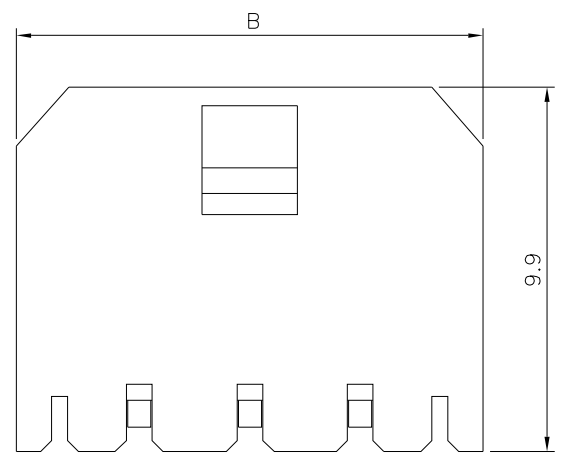


SPECIFICATION

- 1.General Characteristics**
3.0mm Micro-Fit Wafer 1XXX DIP 90° With Post Black Insulator Withstand High Temperature
- 2.Material&Finish**
Insulator:LCP(UL94V-0),Black
Contact:0.625mm Square Pins,Brass,Tin Plated
- 3.Electrical Characteristics**
Current Rating:

Wire Size	#20	#22	#24	#26	#28	#30
Amp	5A	5A	4A	3A	2A	1A

- Voltage Rating:250V AC(RMS)/DC
- Contact Resistance:10 Milliohms Max.
- Dielectric Strength:1500V AC/Minute
- 4.Environmental Characteristics**
Operating Temperature:-40°C~+105°C
- 5.RoHS Compliant**



Pin	A	B
2	3.0	9.65
3	6.0	12.65
4	9.0	15.65
5	12.0	18.65
6	15.0	21.65
7	18.0	24.65
8	21.0	27.65
9	24.0	30.65
10	27.0	33.65
11	30.0	36.65
12	33.0	39.65

4UCON 元化興業股份有限公司
4UCON TECHNOLOGY INC.

DRAWING No.		APPROVED BY		UNLESS OTHERWISE SPECIFIED TOLERANCES ARE .X ±0.25 .XX ±0.15 .XXX ±0.05
10545		MEI		
		CHECKED BY	HZF	
		DRAWING BY	CYP	
SCALE	NONE	REV.	BO	UNIT mm

△ BO	NEW RELEASE	HZF	12/25/2017
NO.REV.	REVISIONS	CHK	DATE